

Radiation Experience with the CMS Pixel Detector

Viktor Veszprémi
Wigner Research Centre for Physics
On behalf of the CMS Collaboration

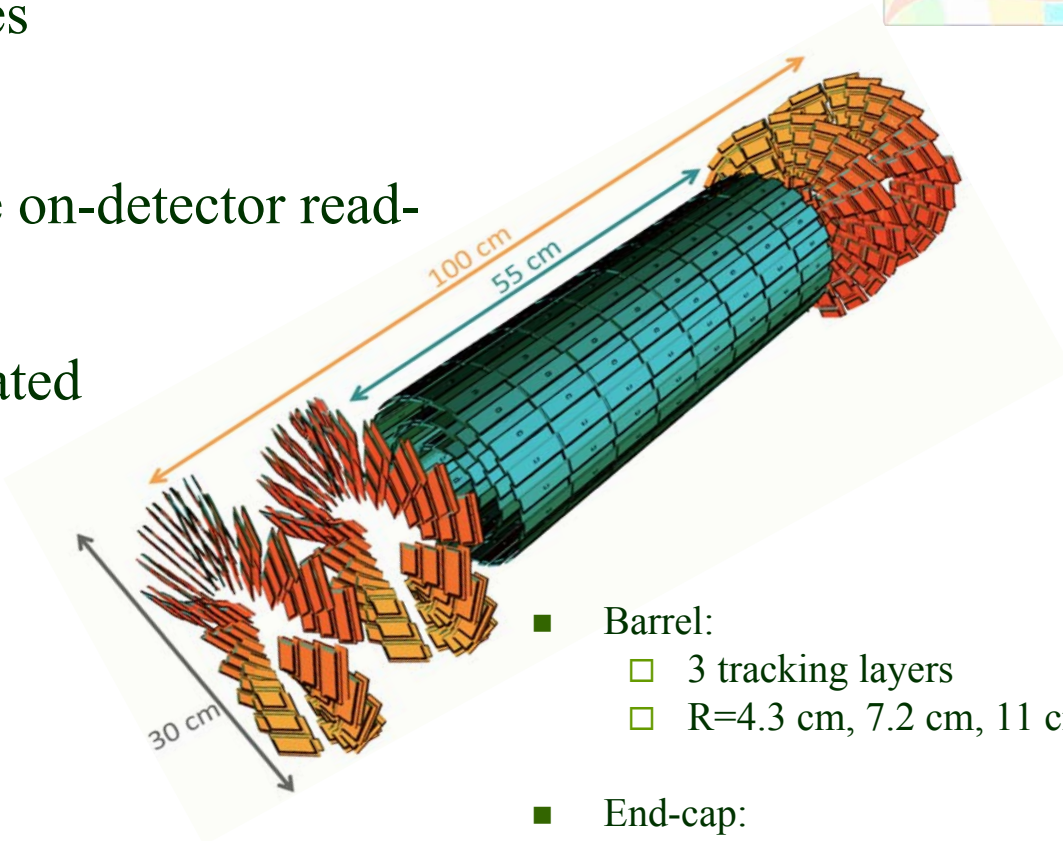
PIXEL 2014

**International Workshop on Semiconductor Pixel Detectors for Particles and Imaging
1-5 September 2014, Niagara Falls, Canada**

Overview

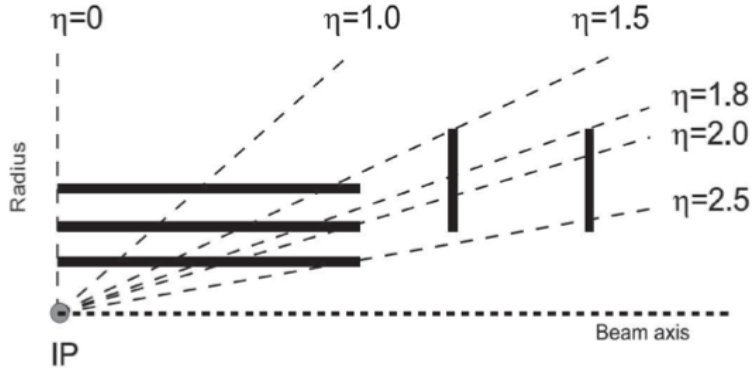


- The CMS pixel modules
- The LHC machine
- Radiation effects of the on-detector read-out electronics
- Properties of the irradiated silicon sensors
- Detector performance



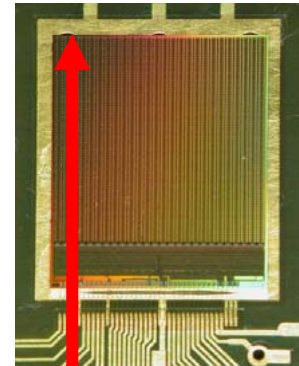
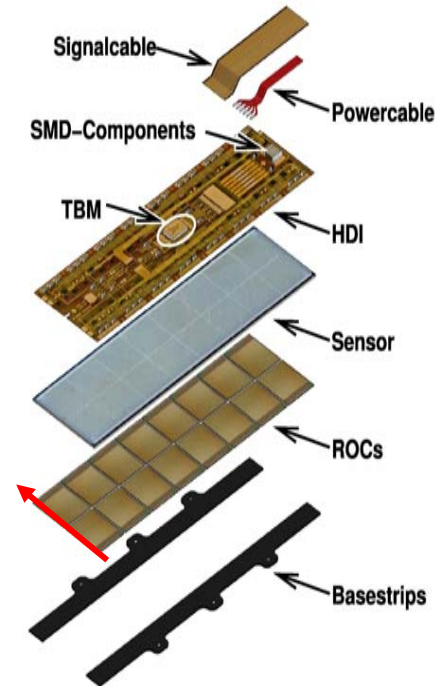
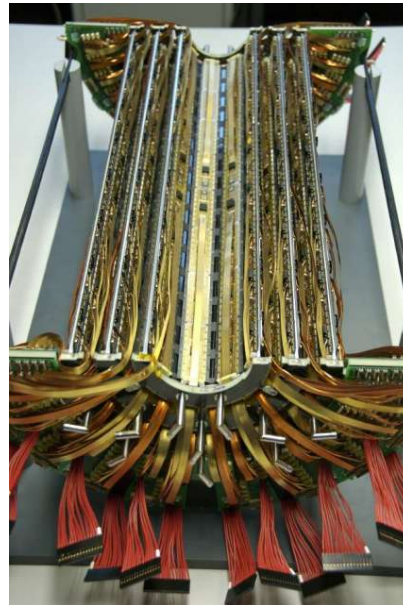
- Barrel:
 - 3 tracking layers
 - $R=4.3$ cm, 7.2 cm, 11 cm
- End-cap:
 - 2 disks on each side
 - $Z=34.5$ cm and 46.5 cm

The pixel modules



- N+-in-n sensor, 66 M pixels
- Pixel size: $100\ \mu\text{m} \times 150\ \mu\text{m} \times 285\ \mu\text{m}$
- Data sparsification of 52×80 pixels by Read Out Chip (ROC)

- Pixels in ROCs are arranged in 26 double columns of 160 pixels
- Double columns are aligned in the azimuthal (radial) direction in the Barrel (End-cap)



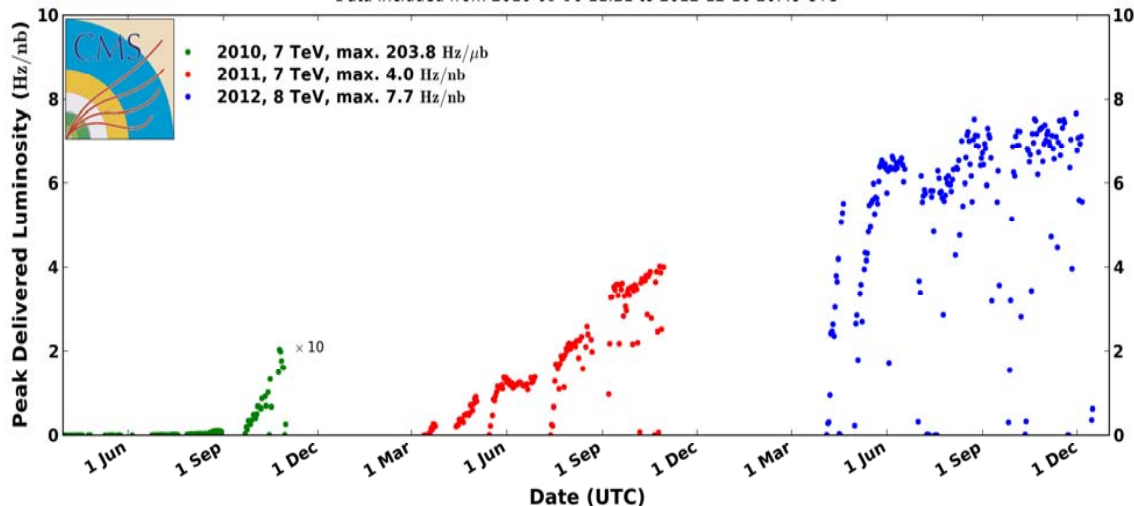
Global- ϕ
(Global-R)

The LHC Machine



CMS Peak Luminosity Per Day, pp

Data included from 2010-03-30 11:21 to 2012-12-16 20:49 UTC



- Improving parameters over Run 1
- 50 ns bunch spacing forced high instantaneous luminosity

- Delivered pp collision data in Run 1

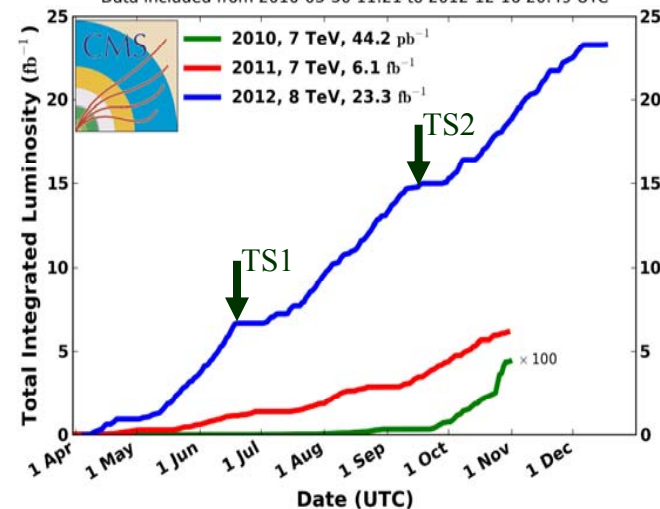
- 7 TeV in 2010: 44.2 pb⁻¹
- 7 TeV in 2011: 6.1 fb⁻¹
- 8 TeV in 2012: 23.3 fb⁻¹

- The 2012 data-taking was interrupted by two Technical Stops (TS). Time used for

- detector calibrations,
- sensor studies

CMS Integrated Luminosity, pp

Data included from 2010-03-30 11:21 to 2012-12-16 20:49 UTC



Radiation effects in the ROC



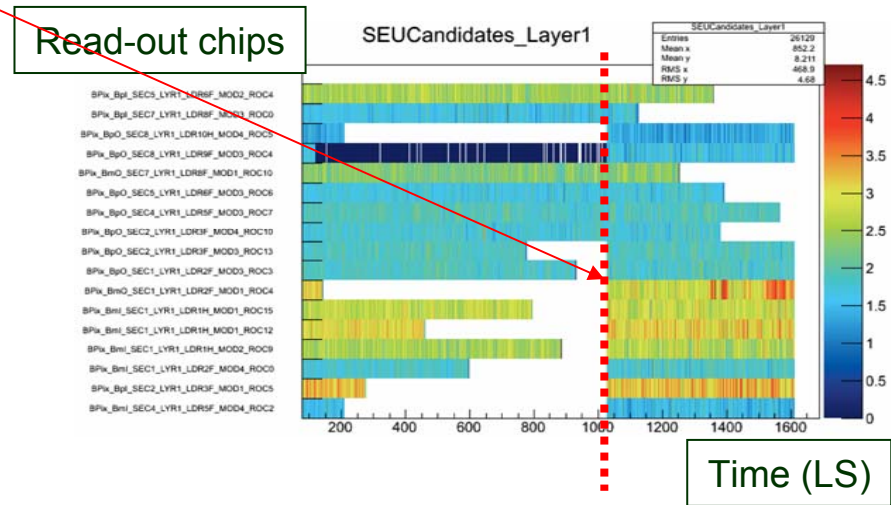
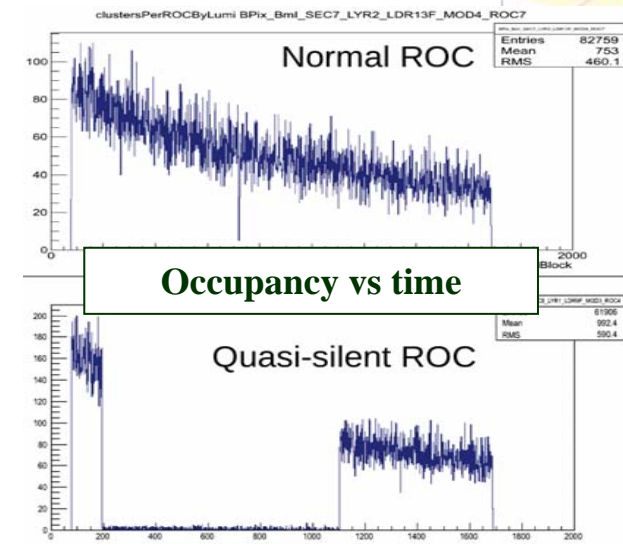
- We have observed both temporary and long-term effects on the ROCs due to irradiation
 - Temporary effects are always connected with instantaneous luminosity (pile-up), a continually changing quantity that makes consistent measurements and detector studies difficult
 - Long-term effects are parameterized by integrated luminosity

- Most significant short-term effects:
 - Single Event Upset in electronics
 - Hit buffer overflow
 - Occupancy-dependent gain calibration
 - Threshold change due to multiple hits in double columns – yet to be investigated

- Long term effects:
 - Gain variation
 - Drifting of pixel read-out thresholds

Single Event Upset

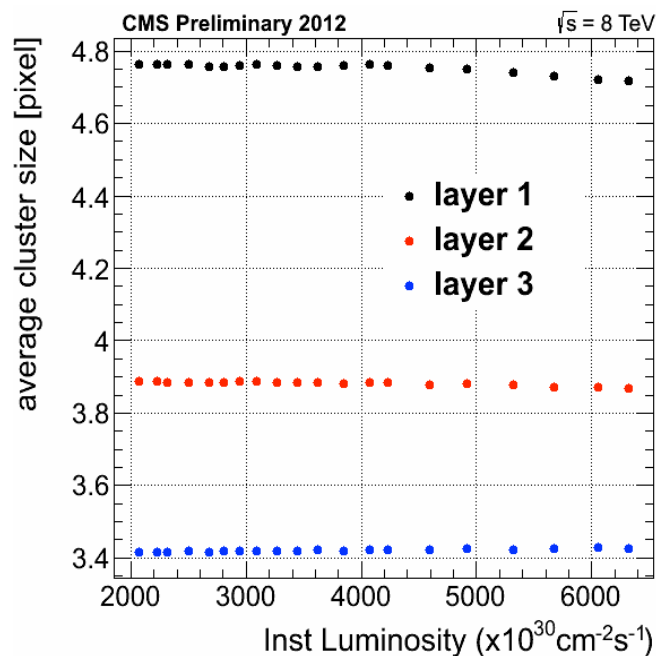
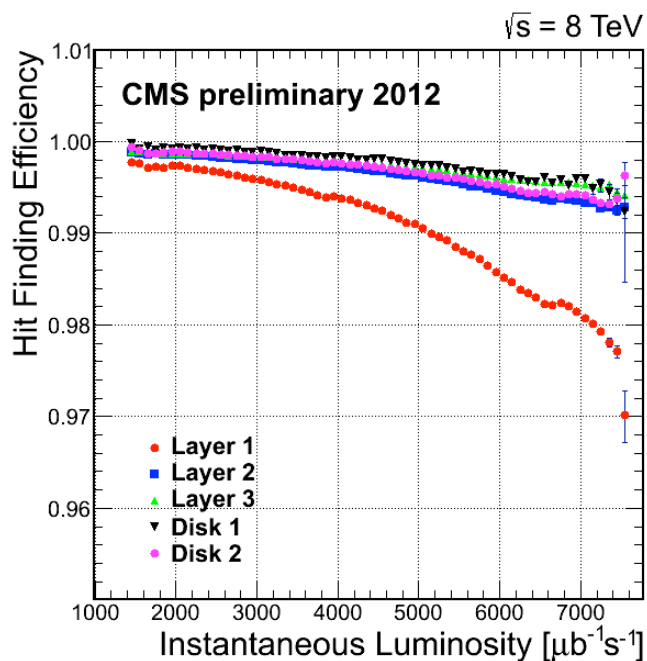
- Particles from collisions can flip bits in control registers of ROCs and auxiliary electronics (Single Event Upset)
- SEU may interrupt or degrade data taking
- Solution is **reprogramming** electronics triggered by
 - Read-out front end
 - Data quality monitoring (manually)
- Entire clusters are lost, results in loss of efficiency but not in changes of cluster properties



Hit buffer overflow



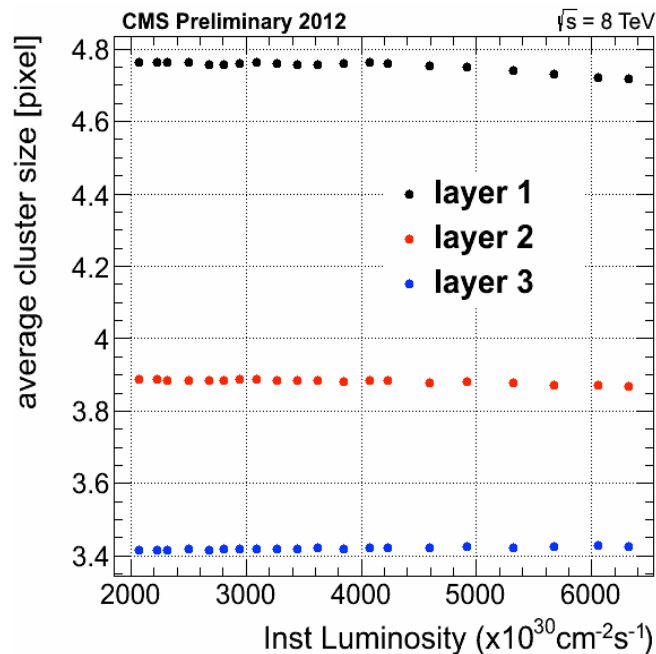
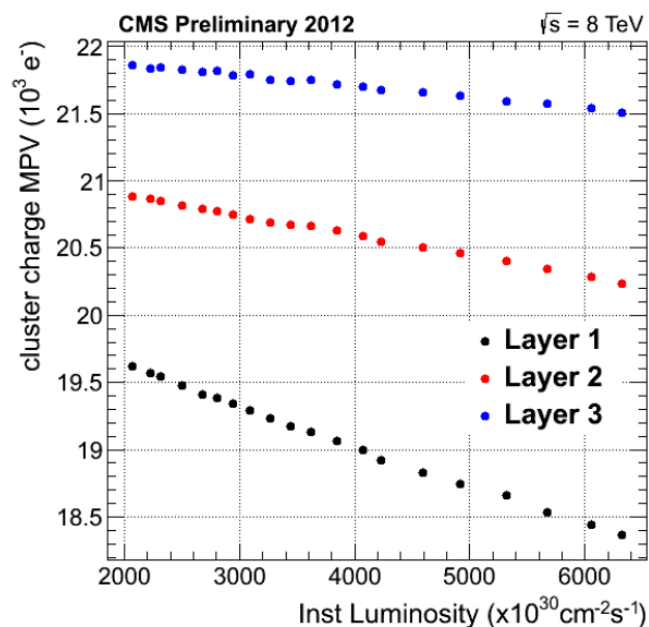
- Higher occupancy fills the internal buffers of the double columns in the ROCs faster leading to buffer overflow
 - Central region: higher chance of losing entire (small) clusters
 - Large- η : long clusters are split into smaller clusters more often
- Net effect is a slight, simultaneous decrease in cluster size and charge – impact is under investigation based on simulation



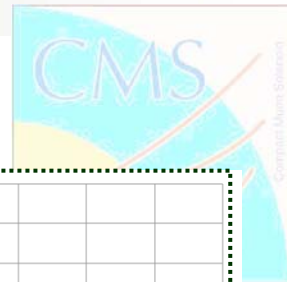
Occupancy-dependent gain calibration



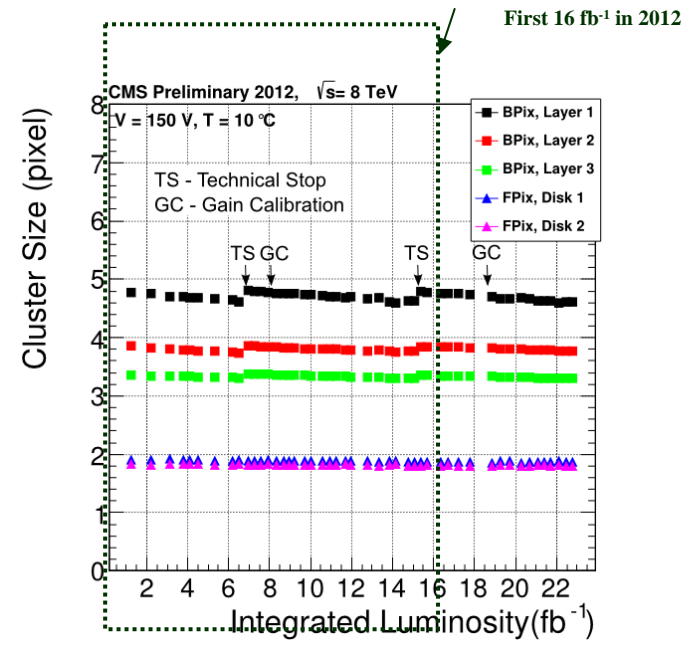
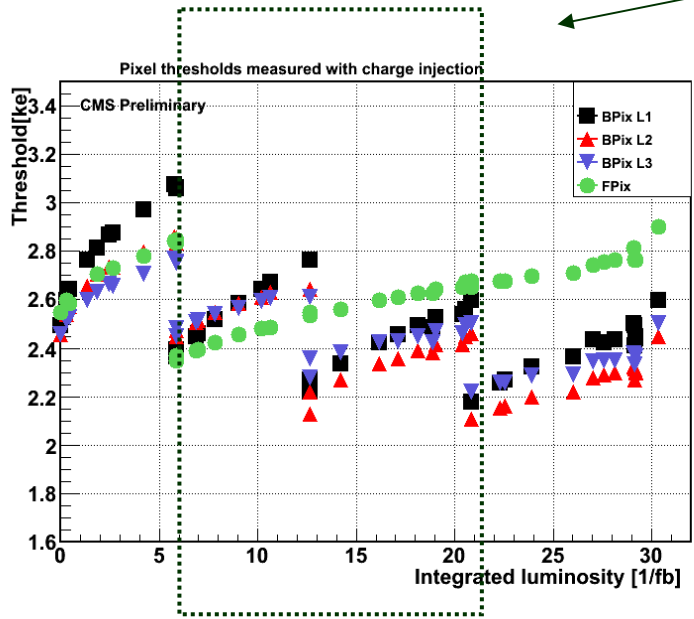
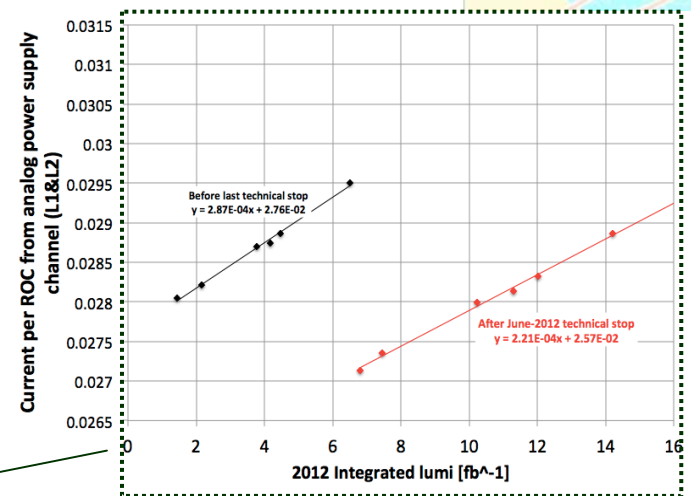
- Higher occupancy increases the power consumption and therefore the temperature in the ROCs
- Pixel charge gain calibration is temperature dependent
 - No significant change in cluster size \rightarrow effect is stronger than results of buffer overflow
 - Visible on all layers
- Mechanism is not yet taken into account in simulation



Long-term variations in threshold



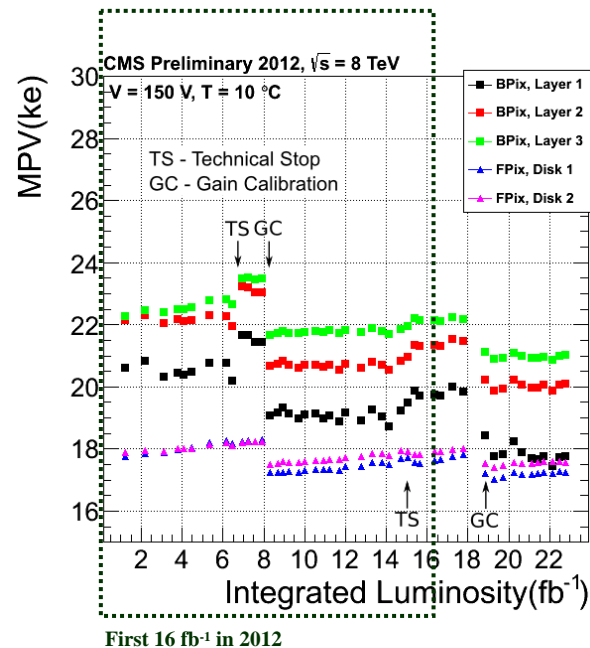
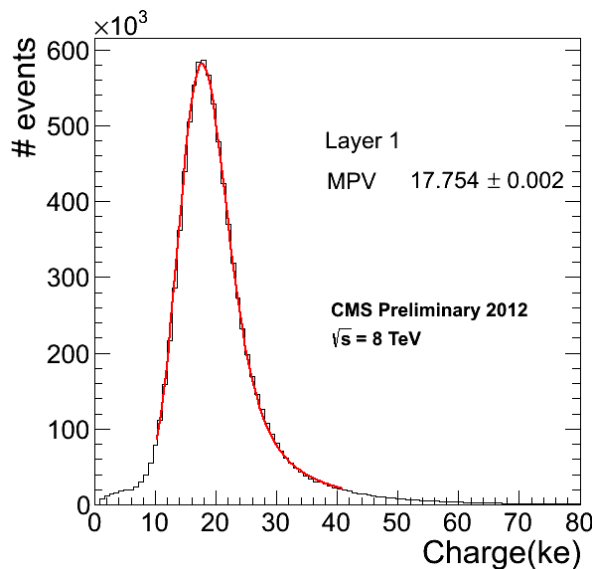
- Threshold is measured with charge injection
- Analog current increases linearly with radiation damage
 - change in units of the analog voltage setting
 - or a drift in reference voltage
- Slower signal rise time leads to higher threshold
 - Confirmed by decrease in cluster size



Long-term variations in gain calibration



- During technical stops in 2012 (TS) thresholds were readjusted (minimized)
 - Slightly increased luminosity in the LHC after TS is overcome by lower thresholds
- After applying cluster charge gain calibration in offline reconstruction (GC), overall MPV decreases
 - Contradicts with thresholds being lower than before TS
- Pixel charge gain is also measured by charge injection
 - Change in units of injected charge?



Radiation effects in the sensors

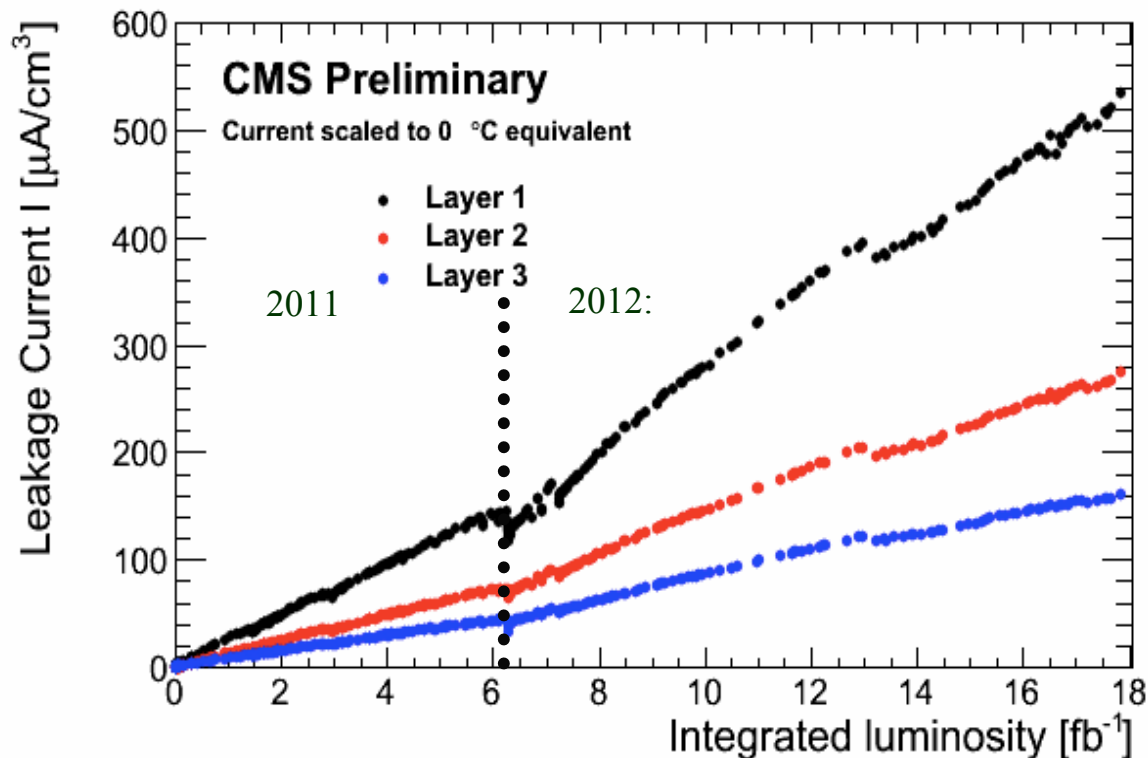


- Leakage current
- Full depletion voltage
- Charge collection profile
- Lorentz-angle

Leakage current



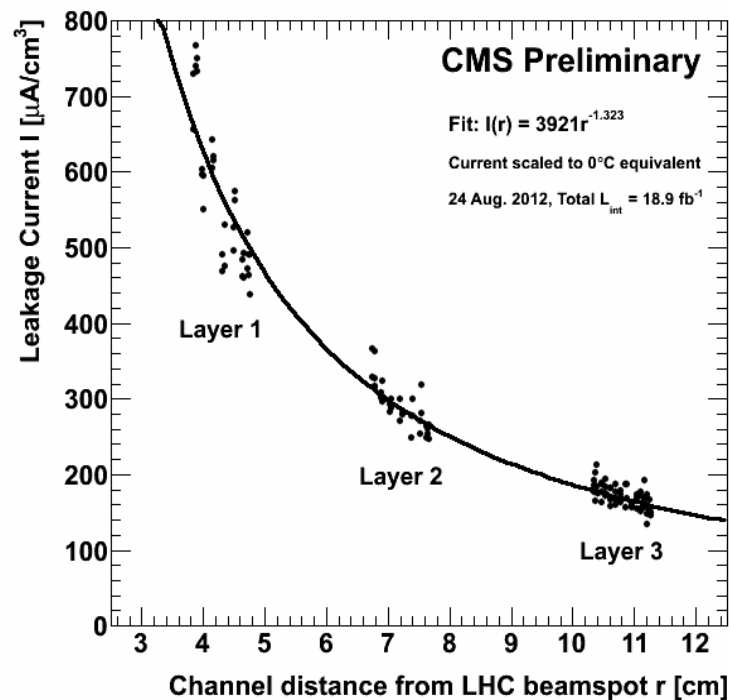
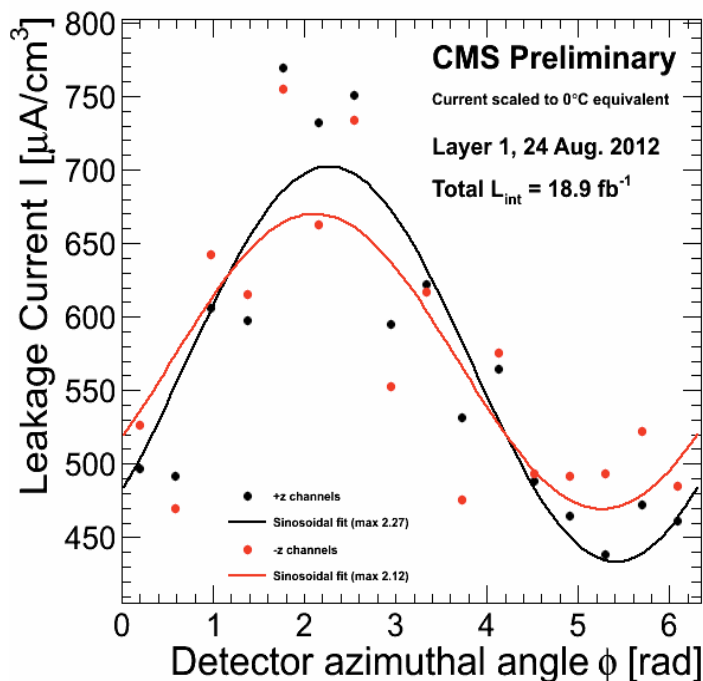
- Measured for each high-voltage channel in the barrel, normalized to volume of the silicon and adjusted to equivalent current at 0°C
- Increases proportionally with irradiation – slope slows when lowering operation (coolant) temperature from 7°C to 0°C
- Reduced by annealing outside beam operation between 2011 and 2012



Leakage current



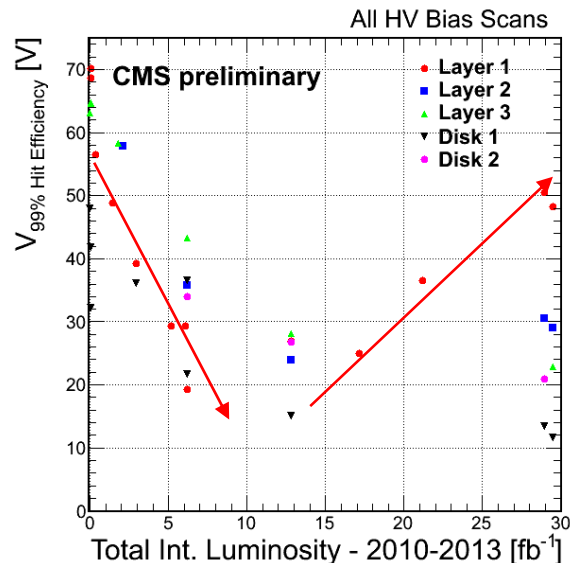
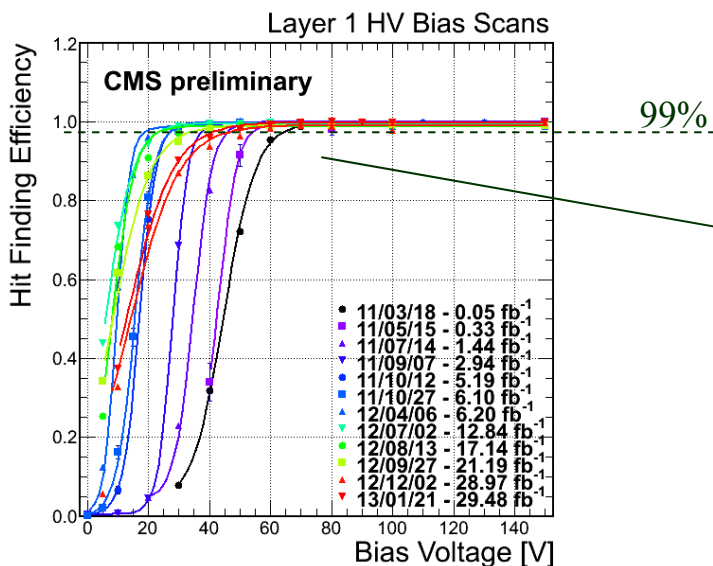
- LHC beam was off-set by a few mm leading to uneven irradiation in the azimuthal angle
- Beam offset enabled us to measure the leakage current also as function of the module radius





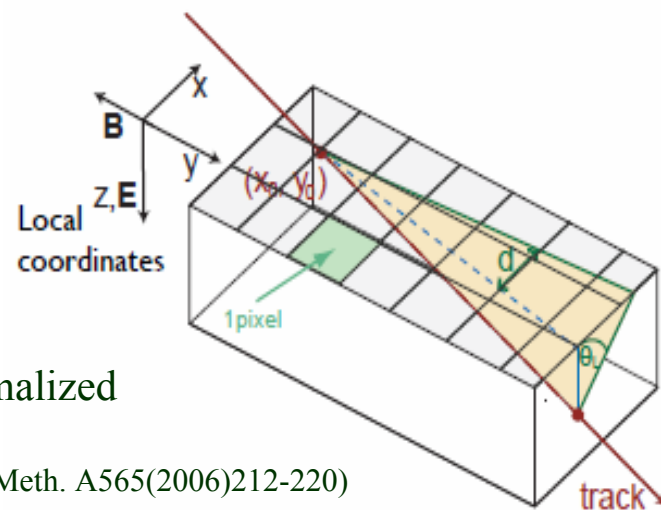
Full depletion voltage in the Pixels

- Irradiation changes the effective doping of the sensor
 - Depletion voltage monitored regularly based on hit efficiency
 - Operational voltage is fixed at 150V (300V) in the barrel (end-cap) pixel – detector sitting on an efficiency plateau
 - No information on charge collection efficiency – measurement needs to improve
 - Consistent normalization of MPV has been difficult due to drifting thresholds and gain calibration
- Evidence for type inversion is observed in Layer 1

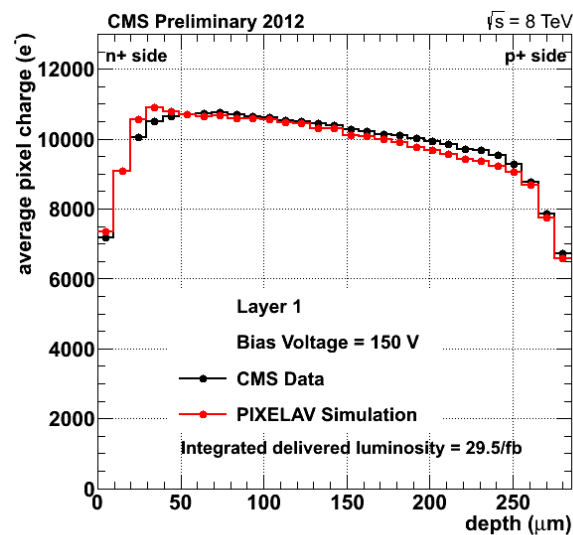
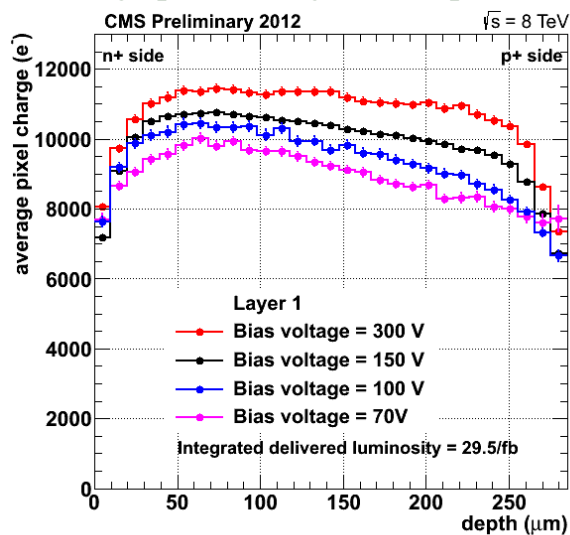


Charge collection profile

- Results of radiation damage
 - Non-uniform electric field scalps charge collection profile
 - Charge carrier trapping
- Charge collection profile implies improved efficiency at higher bias voltage, but pixel charge is not properly normalized
- Effective model is used to describe data (PIXELAV: Nucl.Instr.Meth. A565(2006)212-220)
 - Key component in cluster position measurement
 - Just being integrated into official CMS simulation



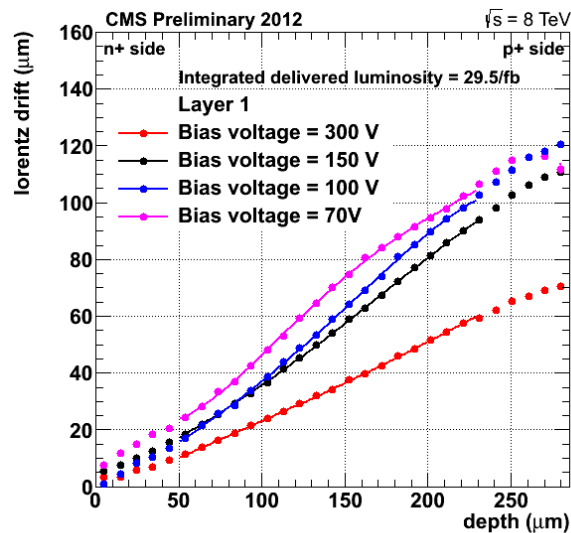
Average pixel charge in a depth „bin”



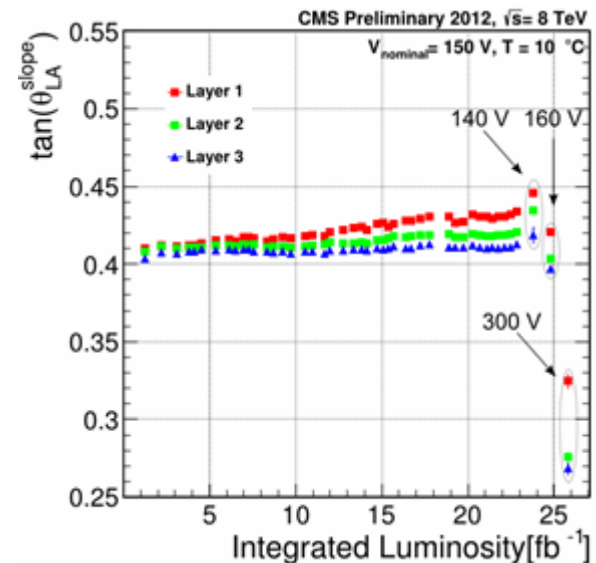
Lorentz-angle



- Lorentz-angle is measured close to mid-plane
 - Magnitude and linearity depends on bias voltage
 - Also evolves with irradiation
- Charge-sharing allows for better resolution in cluster position
 - Charge width may be estimated from the Lorentz-angle when computing cluster position



Lorentz-drift as function of depth in Layer 1

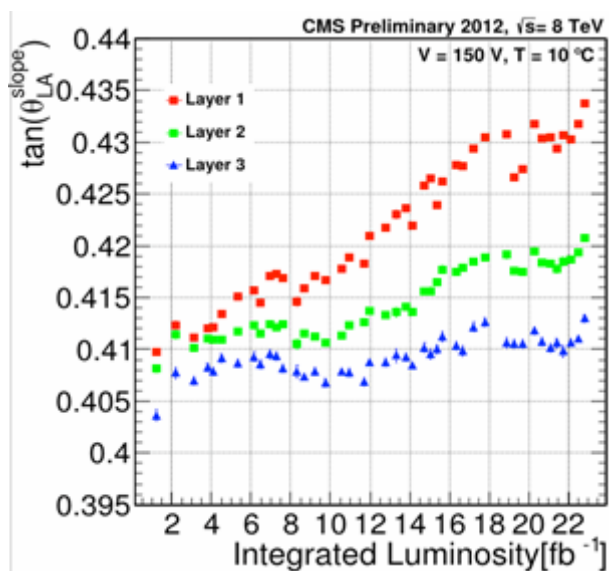


Lorentz-angle at various bias voltages

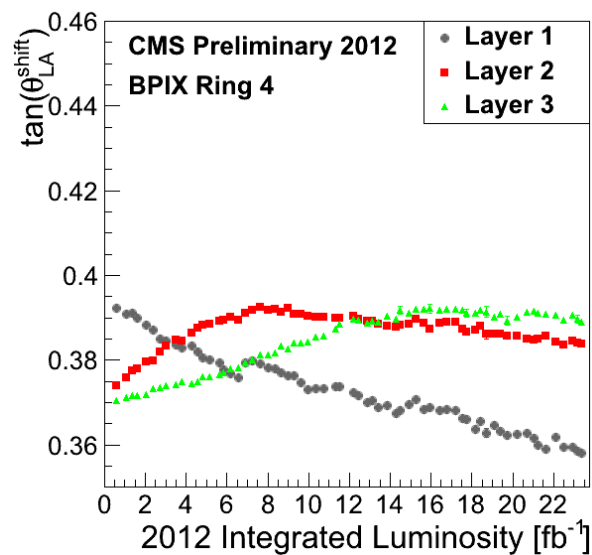
Lorentz-shift



- Single Lorentz-angle value is insufficient to describe cluster position
- A „Lorentz-shift” has been measured externally based on Tracker alignment information
 - Method compares virtual module-displacement (i.e. common shift of all cluster positions) between 0T and full magnetic fields
 - θ_{LA}^{shift} is computed such that $\Delta x = \tan(\theta_{LA}^{shift}) \cdot d/2$
 - Results are confirmed by comparing drifts in inner and outward facing modules



Lorentz-angle at nominal bias voltage



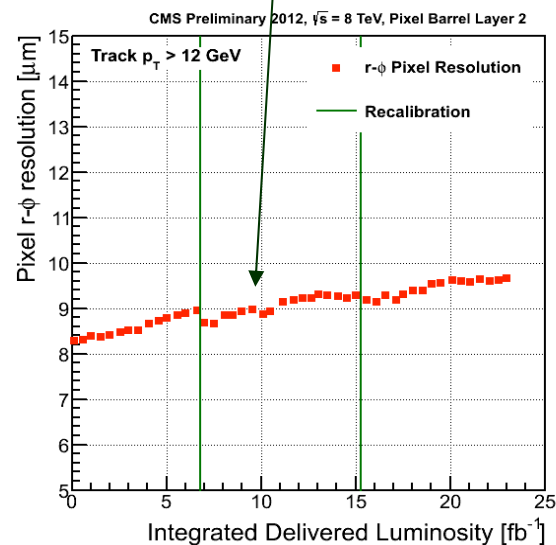
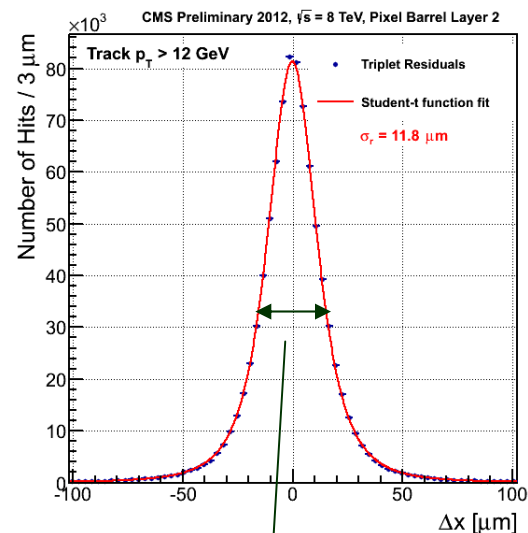
Lorentz-shift at nominal bias voltage

(sorry about the different color codes)

Detector performance: resolution



- Resolution, along with hit detection efficiency, is the most important parameter of the Tracker
 - Intrinsic resolution in the pixel is $\sim 10 \mu\text{m}$
- Hit position is determined by cluster charge template fitting
- Resolution depends on
 - Stability of gain calibration
 - Pixel read-out threshold
 - Precise modeling of Lorentz-angle induced charge-sharing
 - ...
- Attempts at optimizing cluster parameterization by performing a scan on Lorentz-angle did not improve the resolution...



Conclusions



- Very good performance in Run 1
- However, significant irradiation effects are just expected to appear in Run 2
- Planned improvements in detector studies/calibrations
 - More frequent and better understood gain calibrations
 - Better bias voltage characterization
 - More focus on studying the End-caps
- Developments in simulations and reconstructions
 - Understanding effects of efficiency loss due to buffer overflow in double columns
 - Better treatment of radiation induced changes in cluster properties by simulation